

**AMENDMENTS TO THE ABSTRACT**

Please substitute the following paragraph(s) for the abstract now appearing in the currently filed specification:

~~An~~ To provide an oscillator device and a transmission and reception device that are usable for implementing high output and wide-band modulation and that can reduce the manufacturing cost. An oscillation circuit [[2]] and a frequency control circuit [[15]] including microstrip lines 5 and 16, respectively, and other components are formed on an oscillation circuit substrate [[1]]. A TM010 mode resonator [[23]] including resonator electrodes 23A and 23B are formed on a dielectric substrate 22 and along with excitation electrodes 24 and 25 are also formed on the dielectric substrate 22 to form a dielectric resonator chip [[21]]. One of ~~Then,~~ the resonator electrodes [[23B]] is fixed to a land [[19]] of the oscillation circuit substrate 1 ~~by using~~ with bumps [[26]], and also, the excitation electrodes 24 and 25 are fixed to the microstrip lines 5 and 16, respectively, ~~by using~~ with bumps [[26]]. With this configuration, the TM010 mode resonator [[23]] can be excited by using the excitation electrodes 24 and 25, and also, the dielectric resonator chip [[21]] can be miniaturized and the manufacturing cost can be decreased accordingly.